# WP5 @INFN

### AIDAinnova - stato attività e preparazione avvio progetto February 8<sup>th</sup>, 2021 Remote Connection

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### WP5 - Depleted Monolithic Active Pixel Sensors



#### Participants: IFAE, CERN, OEAW, CEA, CNRS, UBONN, INFN, CSIC, UOXF

#### Task 5.2. Development of high granularity DMAPS

DMAPS with high granularity (excellent position resolution), low mass and low power dissipation will be designed targeting specific experiments, like the vertex detectors of the Belle II upgrade, ALICE and Higgs factories. The challenges are to fit the needed electronics in a small pixel while also consuming little power. This can be achieved by exploiting the more relaxed timing requirements. A major effort is needed for the successful design of these devices following the guidance provided by simulating the prototype performance. After design validation, the ASICs will be submitted for fabrication. At this stage, close interaction with the foundry is needed. After the devices are received, they will be first tested in various laboratories and characterised. The final validation will be the test with particle beams. Afterwards the devices will be irradiated to the desired fluence (depending on the target application) and their performance will be re-evaluated in laboratories and with particle beams.

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- Two EOIs submitted during the preparation of the proposal: ARCADIA++ and ThinCMOS
- Similar goal with lots of synergies: <u>Development of next generation monolithic CMOS devices</u>.
  - Develop a demonstrator system that can be used in future experiments and upgrades
  - Improvements in many directions: timing, thickness, speed, power, area, bendability,...
  - Arcadia++ more focused on future colliders (ALICE, Higgs factories)
  - ThinCMOS more focused on Belle II upgrade
- Many sections involved:
  - **ARCADIA++**: BO (A. Gabrielli), MI (M. Caccia), PD (J. Wyss), PV (G. Traversi), PG (P. Placidi), TIFPA (L. Pancheri), TO (Da Rocha Rolo)
  - ThinCMOS: PI (F.Forti), PV (L.Ratti)
- Main resources needed:
  - Silicon must be funded through other projects
  - People essential for building expertise: main purpose of AIDAinnova budget (max 4 AdR)

### WP5: Workplan



- Arcadia++ : ARCADIA has currently a CNS5 call ongoing
  - mostly INFN effort, builds on silicon proven CMOS technology (funded by SEED-CSN5)
  - close collaboration with LFoundry for the development of sensor technology
- ThinCMOS: The Belle II effort is still in its infancy
  - Funding sources not clear and will be defined later
  - Several nations involved, needs to be harmonized
- Synergy Synergy
  - In any case the plan is to exploit the synergies and join forces for the developments, with the goal of developing a larger community and more complete expertise
  - The plan is to use the manpower hired through AIDAinnova for both projects.
- "Affinity" with current INFN projects
  - Arcadia++: ARCADIA, ALICE, RD\_FCC
  - ThinCMOS: BELLEII

### **WP5: Work Actions**



#### Gestione coordinata

Ogni proposta di AdR (co-finanziato) discussa dai coordinatori INFN del WP5 (F Forti, M Rolo).
Questa gestione coordinata e trasparente potenzierà la ricerca di sinergie ad ogni fase del progetto. I fondi AIDAinnova verranno usati <u>esclusivamente per AdR co-finanziati</u>;

#### Sedi partecipanti e proposta di rendicontazione

- BO (A. Gabrielli), MI (M. Caccia), PD (J. Wyss), PV (G. Traversi, L. Ratti), PG (P. Placidi), PI (F. Forti), TIFPA (L. Pancheri), TO (M. Rolo);
- Le sezioni TO e PI espongono in partenza i PM necessari alla rendicontazione del contributo *inkind* INFN, mentre la rendicontazione a consuntivo sarà vincolata alle sedi (dalle 8 elencate) che useranno effettivamente i fondi per generare AdR;
- All'inizio di ogni anno del progetto (03/2021, 03/2022,...) le sedi che useranno il finanziamento per finanziare AdR l'anno successivo esporranno gli FTE necessari alla rendicontazione nel DB INFN Preventivi.